LM78XX Series Voltage Regulators

Check for Samples: LM7805C, LM7812C, LM7815C

FEATURES

- **Output Current in Excess of 1A**
- **Internal Thermal Overload Protection**
- **No External Components Required**
- **Output Transistor Safe Area Protection**
- **Internal Short Circuit Current Limit**
- **Available in the Aluminum TO-3 Package**

DESCRIPTION

The LM78XX series of three terminal regulators is available with several fixed output voltages making them useful in a wide range of applications. One of these is local on card regulation, eliminating the distribution problems associated with single point regulation. The voltages available allow these regulators to be used in logic systems, instrumentation, HiFi, and other solid state electronic equipment. Although designed primarily as fixed voltage regulators these devices can be used with external components to obtain adjustable voltages and currents.

The LM78XX series is available in an aluminum TO-3 package which will allow over 1.0A load current if adequate heat sinking is provided. Current limiting is included to limit the peak output current to a safe value. Safe area protection for the output transistor is provided to limit internal power dissipation. If internal power dissipation becomes too high for the heat sinking provided, the thermal shutdown circuit takes over preventing the IC from overheating.

Considerable effort was expanded to make the LM78XX series of regulators easy to use and minimize the number of external components. It is not necessary to bypass the output, although this does improve transient response. Input bypassing is needed only if the regulator is located far from the filter capacitor of the power supply.

For output voltage other than 5V, 12V and 15V the LM117 series provides an output voltage range from 1.2V to 57V.

Voltage Range

LM7805C	5V
LM7812C	12V
LM7815C	15V

Connection Diagrams

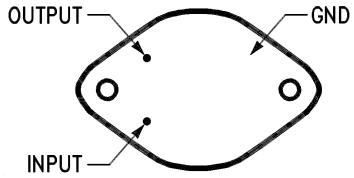


Figure 1. Metal Can Package
TO-3
Aluminum
Bottom View

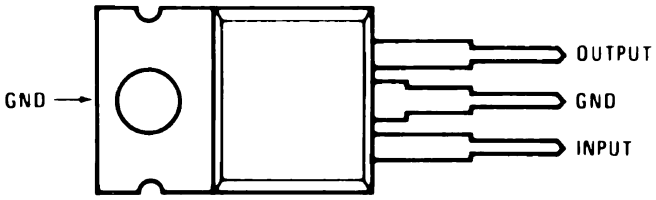
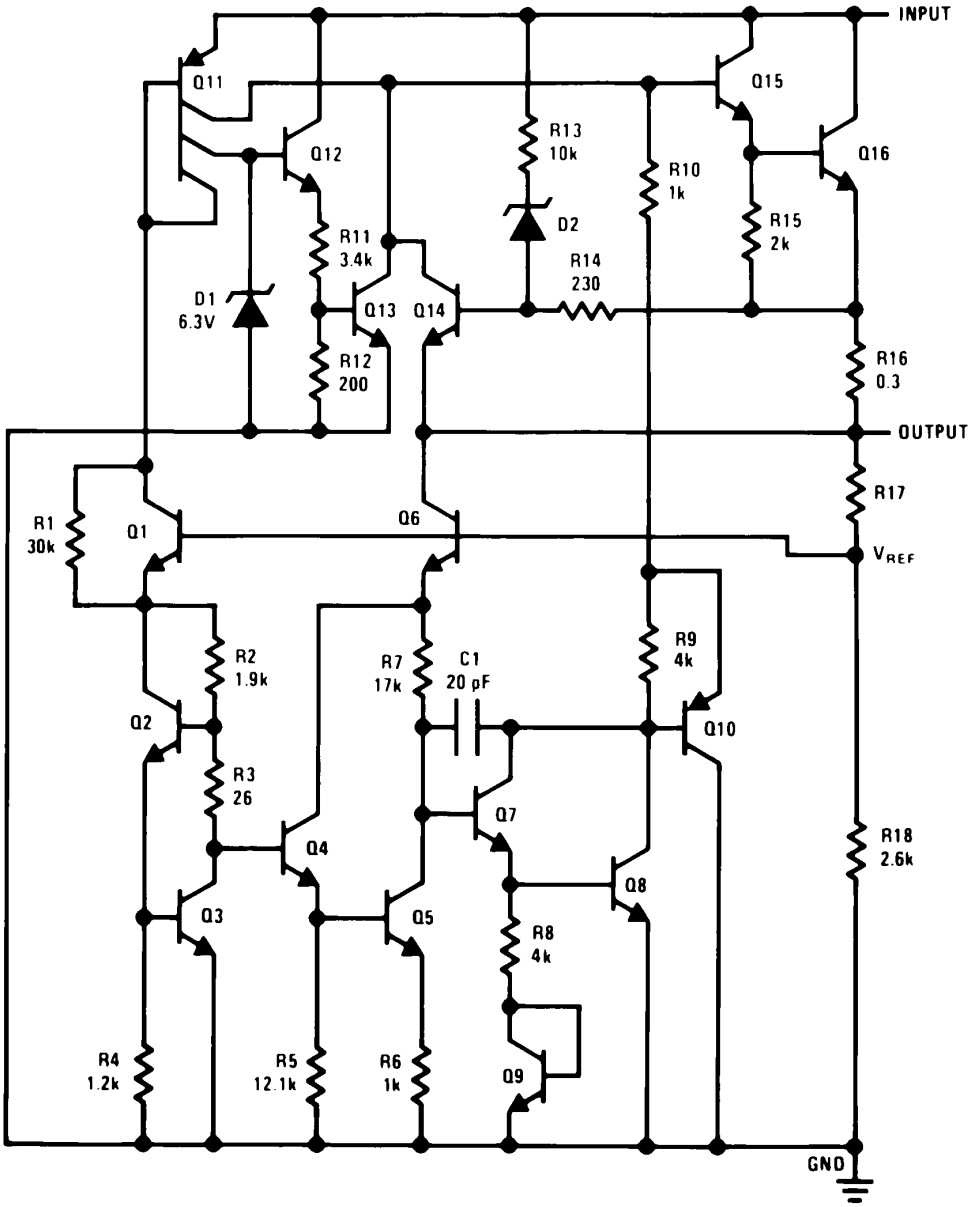


Figure 2. Plastic Package
TO-220 (NDE)
Top View
See Package Number NDE0003B

SCHEMATIC DIAGRAM



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS(1)(2)

Input Voltage	
(V_O = 5V, 12V and 15V)	35V
Internal Power Dissipation (3)	Internally Limited
Operating Temperature Range (T_A)	0°C to +70°C
Maximum Junction Temperature	
(TO-3 Package)	150°C
(NDE Package)	150°C
Storage Temperature Range	−65°C to +150°C
Lead Temperature (Soldering, 10 sec.)	
TO-3 Package	300°C
TO-220 Package NDE	230°C

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. For ensured specifications and the test conditions, see Electrical Characteristics.
(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
(3) Thermal resistance of the TO-3 package is typically 4°C/W junction to case and 35°C/W case to ambient. Thermal resistance of the TO-220 package (NDE) is typically 4°C/W junction to case and 50°C/W case to ambient.

ELECTRICAL CHARACTERISTICS LM78XXC(1)

0°C ≤ T_J ≤ 125°C unless otherwise noted.

Output Voltage				**5V**			**12V**			**15V**			**Units**
Input Voltage (unless otherwise noted)				**10V**			**19V**			**23V**			
Symbol	**Parameter**	**Conditions**		**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	
V_O	Output Voltage	Tj = 25°C, 5 mA ≤ I_O ≤ 1A		4.8	5	5.2	11.5	12	12.5	14.4	15	15.6	V
		P_D ≤ 15W, 5 mA ≤ I_O ≤ 1A		4.75		5.25	11.4		12.6	14.2		15.7	V
		V_{MIN} ≤ V_{IN} ≤ V_{MAX}		(7.5 ≤ V_{IN} ≤ 20)			(14.5 ≤ V_{IN} ≤ 27)			(17.5 ≤ V_{IN} ≤ 30)			V
ΔV_O	Line Regulation	I_O = 500 mA	Tj = 25°C		3	50		4	120		4	150	mV
			ΔV_{IN}	(7 ≤ V_{IN} ≤ 25)			14.5 ≤ V_{IN} ≤ 30)			(17.5 ≤ V_{IN} ≤ 30)			V
			0°C ≤ Tj ≤ +125°C			50			120			150	mV
			ΔV_{IN}	(8 ≤ V_{IN} ≤ 20)			(15 ≤ V_{IN} ≤ 27)			(18.5 ≤ V_{IN} ≤ 30)			V
		I_O ≤ 1A	Tj = 25°C			50			120			150	mV
			ΔV_{IN}	(7.5 ≤ V_{IN} ≤ 20)			(14.6 ≤ V_{IN} ≤ 27)			(17.7 ≤ V_{IN} ≤ 30)			V
			0°C ≤ Tj ≤ +125°C			25			60			75	mV
			ΔV_{IN}	(8 ≤ V_{IN} ≤ 12)			(16 ≤ V_{IN} ≤ 22)			(20 ≤ V_{IN} ≤ 26)			V
ΔV_O	Load Regulation	Tj = 25°C	5 mA ≤ I_O ≤ 1.5A		10	50		12	120		12	150	mV
			250 mA ≤ I_O ≤ 750 mA			25			60			75	mV
		5 mA ≤ I_O ≤ 1A, 0°C ≤ Tj ≤ +125°C				50			120			150	mV
I_Q	Quiescent Current	I_O ≤ 1A	Tj = 25°C			8			8			8	mA
			0°C ≤ Tj ≤ +125°C			8.5			8.5			8.5	mA

(1) All characteristics are measured with capacitor across the input of 0.22 µF, and a capacitor across the output of 0.1µF. All characteristics except noise voltage and ripple rejection ratio are measured using pulse techniques (t_w ≤ 10 ms, duty cycle ≤ 5%). Output voltage changes due to changes in internal temperature must be taken into account separately.

ELECTRICAL CHARACTERISTICS LM78XXC[1] (continued)

0°C ≤ T_J ≤ 125°C unless otherwise noted.

Output Voltage			5V			12V			15V			Units
Input Voltage (unless otherwise noted)			10V			19V			23V			
Symbol	Parameter	Conditions	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
ΔI_Q	Quiescent Current Change	5 mA ≤ I_O ≤ 1A			0.5			0.5			0.5	mA
		Tj = 25°C, I_O ≤ 1A			1.0			1.0			1.0	mA
		V_{MIN} ≤ V_{IN} ≤ V_{MAX}	(7.5 ≤ V_{IN} ≤ 20)			(14.8 ≤ V_{IN}≤ 27)			(17.9 ≤ V_{IN} ≤ 30)			V
		I_O ≤ 500 mA, 0°C ≤ Tj ≤ +125°C			1.0			1.0			1.0	mA
		V_{MIN} ≤ V_{IN} ≤ V_{MAX}	(7 ≤ V_{IN} ≤ 25)			(14.5 ≤ V_{IN}≤ 30)			(17.5 ≤ V_{IN} ≤ 30)			V
V_N	Output Noise Voltage	T_A =25°C, 10 Hz ≤ f ≤ 100 kHz		40			75			90		µV
$\Delta V_{IN}/\Delta V_{OUT}$	Ripple Rejection	f = 120 Hz I_O ≤ 1A, Tj = 25°C or	62	80		55	72		54	70		dB
		I_O ≤ 500 mA 0°C ≤ Tj ≤ +125°C	62			55			54			dB
		V_{MIN} ≤ V_{IN} ≤ V_{MAX}	(8 ≤ V_{IN} ≤ 18)			(15 ≤ V_{IN} ≤ 25)			(18.5 ≤ V_{IN} ≤ 28.5)			V
R_O	Dropout Voltage	Tj = 25°C, I_{OUT} = 1A		2.0			2.0			2.0		V
	Output Resistance	f = 1 kHz		8			18			19		mΩ
	Short-Circuit Current	Tj = 25°C		2.1			1.5			1.2		A
	Peak Output Current	Tj = 25°C		2.4			2.4			2.4		A
	Average TC of V_{OUT}	0°C ≤ Tj ≤ +125°C, I_O = 5 mA		0.6			1.5			1.8		mV/°C
V_{IN}	Input Voltage Required to Maintain Line Regulation	Tj = 25°C, I_O ≤ 1A		7.5		14.6			17.7			V

TYPICAL PERFORMANCE CHARACTERISTICS

Maximum Average Power Dissipation

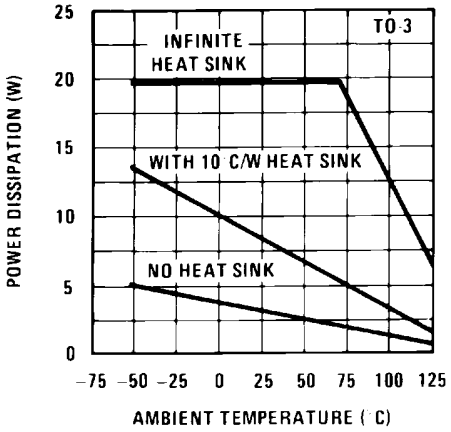


Figure 3.

Maximum Average Power Dissipation

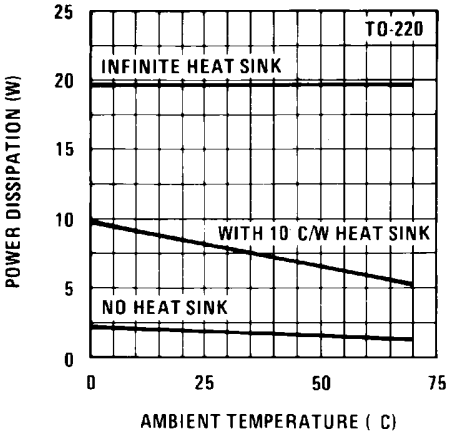


Figure 4.

Peak Output Current

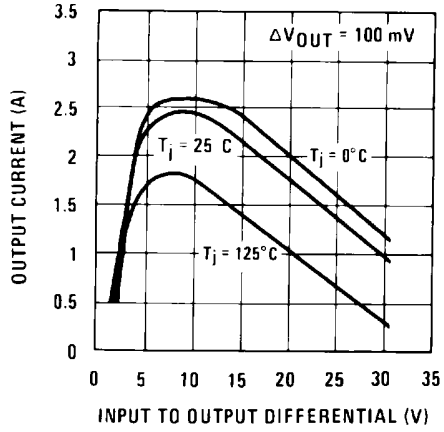


Figure 5.

Output Voltage (Normalized to 1V at T_J = 25°C)

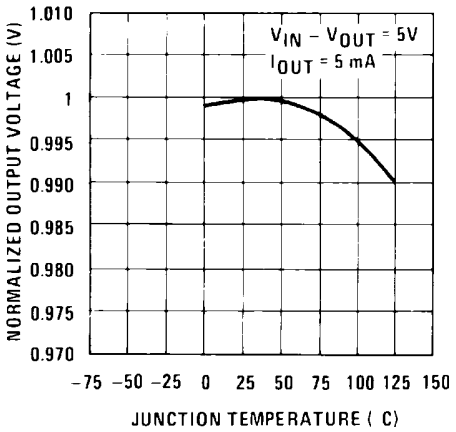


Figure 6.

Ripple Rejection

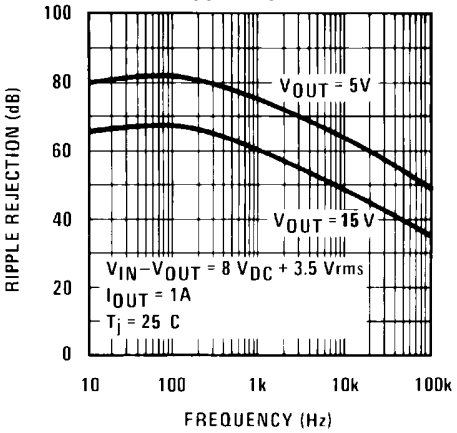


Figure 7.

Ripple Rejection

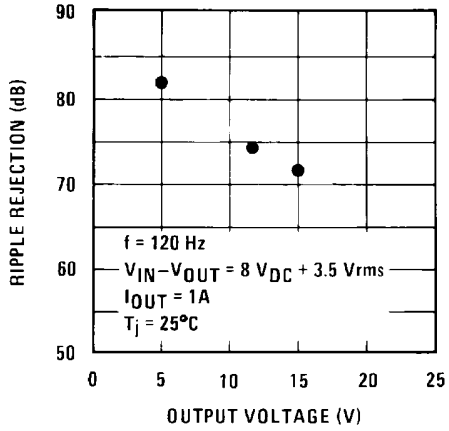


Figure 8.

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

Output Impedance

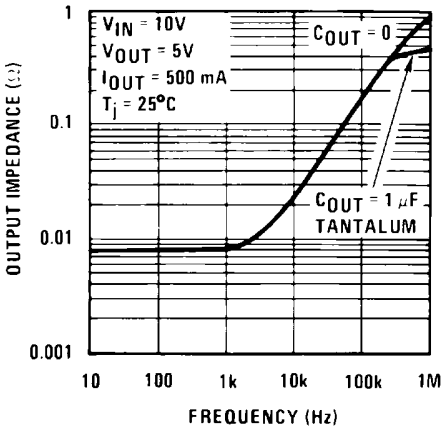


Figure 9.

Dropout Voltage

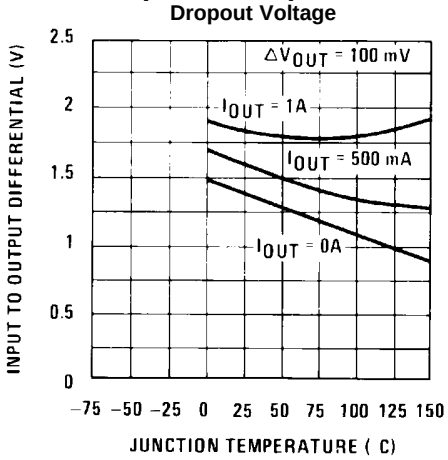


Figure 10.

Dropout Characteristics

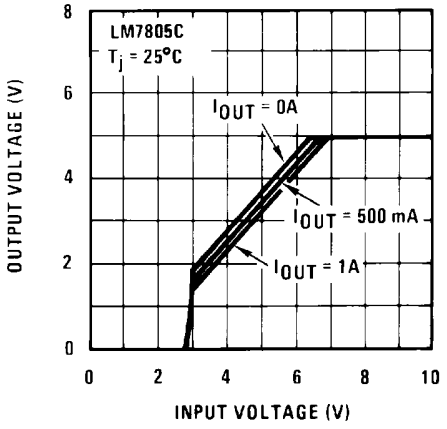


Figure .

Quiescent Current

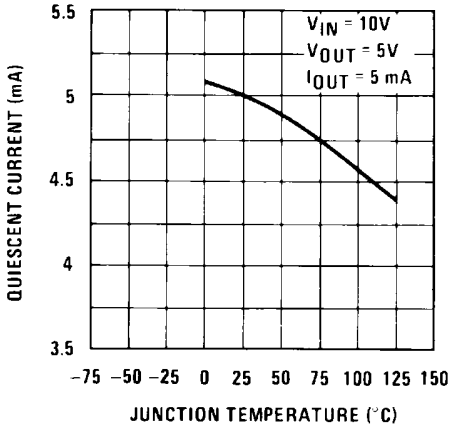


Figure 11.

Quiescent Current

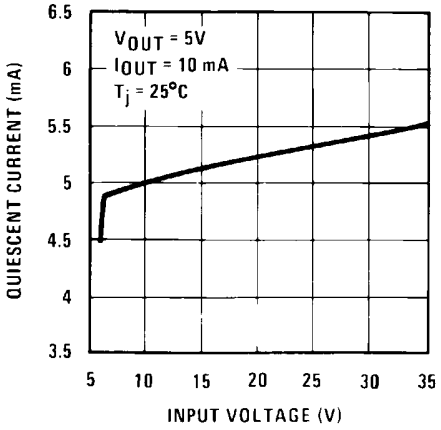


Figure 12.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LM7805CT	ACTIVE	TO-220	NDE	3	45	TBD	Call TI	Call TI	0 to 70	LM340T5 7805 P+	Samples
LM7805CT/NOPB	ACTIVE	TO-220	NDE	3	45	Pb-Free (RoHS Exempt)	CU SN	Level-1-NA-UNLIM	0 to 70	LM340T5 7805 P+	Samples
LM7815CT	ACTIVE	TO-220	NDE	3	45	TBD	Call TI	Call TI	0 to 70	LM340T15 7815 P+	Samples
LM7815CT/NOPB	ACTIVE	TO-220	NDE	3	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	0 to 70	LM340T15 7815 P+	Samples

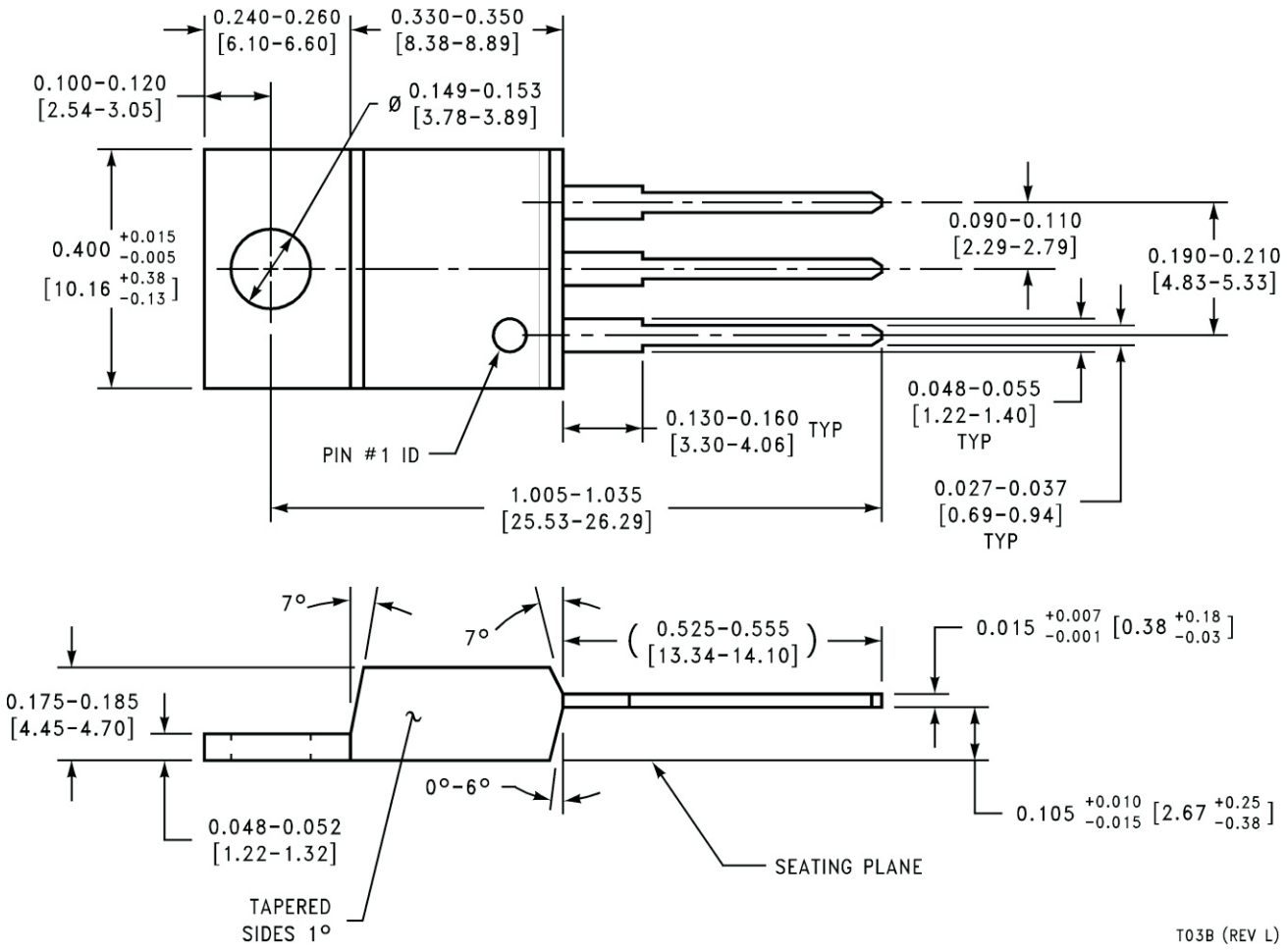
(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

NDE0003B


0.240-0.260
[6.10-6.60]
0.330-0.350
[8.38-8.89]
0.100-0.120
[2.54-3.05]
Ø 0.149-0.153
[3.78-3.89]
0.400 +0.015 -0.005
[10.16 +0.38 -0.13]
0.090-0.110
[2.29-2.79]
0.190-0.210
[4.83-5.33]
0.048-0.055
[1.22-1.40]
TYP
0.130-0.160 TYP
[3.30-4.06]
PIN #1 ID
1.005-1.035
[25.53-26.29]
0.027-0.037
[0.69-0.94]
TYP
7°
7°
(0.525-0.555
[13.34-14.10])
0.015 +0.007 -0.001 [0.38 +0.18 -0.03]
0.175-0.185
[4.45-4.70]
0°-6°
0.105 +0.010 -0.015 [2.67 +0.25 -0.38]
0.048-0.052
[1.22-1.32]
SEATING PLANE
TAPERED
SIDES 1°
T03B (REV L)

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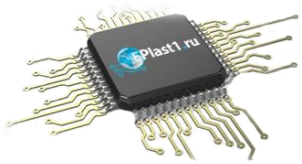
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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